

October 1987 Revised January 1999

# MM74C901 • MM74C902 Hex Inverting TTL Buffer • Hex Non-Inverting TTL Buffer

#### **General Description**

The MM74C901 and MM74C902 hex buffers employ complementary MOS to achieve wide supply operating range, low power consumption, and high noise immunity. These buffers provide direct interface from PMOS into CMOS or TTL and direct interface from CMOS to TTL or CMOS operating at a reduced  $\ensuremath{\text{V}_{\text{CC}}}$  supply.

#### **Features**

■ Wide supply voltage range: 3.0V to 15V

■ Guaranteed noise margin: 1.0V
 ■ High noise immunity: 0.45 V<sub>CC</sub> (typ.)

■ TTL compatibility: Fan out of 2 driving standard TTL

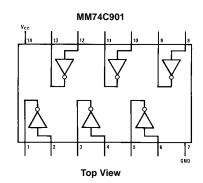
## **Ordering Code:**

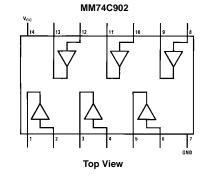
Order Number	Package Number	Package Description
MM74C901M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150" Narrow
MM74C901N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-011, 0.300" Wide
MM74C902M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150" Narrow
MM74C902N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-011, 0.300" Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

## **Connection Diagrams**

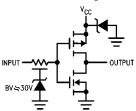
#### Pin Assignments for DIP and SOIC



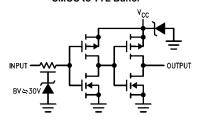


#### **Logic Diagrams**

MM74C901
CMOS to TTL Inverting Buffer



#### MM74C902 CMOS to TTL Buffer



### **Absolute Maximum Ratings**(Note 1)

Voltage at Any Pin  $$-0.3\mbox{V}$\ to \mbox{V}_{\mbox{CC}}$ + 0.3\mbox{V}$$ 

Voltage at Any Input Pin

MM74C901 -0.3V to +15V MM74C902 -0.3V to +15V

Storage Temperature Range (T<sub>S</sub>)

Power Dissipation (P<sub>D</sub>)

Dual-In-Line 700 mW
Small Outline 500 mW

 $-65^{\circ}C$  to  $+150^{\circ}C$ 

Operating Temperature Range (T<sub>A</sub>)

MM74C901, MM74C902, -40°C to +85°C

 $\begin{array}{ll} \text{Operating V}_{\text{CC}} \; \text{Range} & 3.0 \text{V to 15V} \\ \text{Absolute Maximum V}_{\text{CC}} & 18 \text{V} \end{array}$ 

Lead Temperature (T<sub>L</sub>)

(Soldering, 10 seconds) 260°C

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

#### **DC Electrical Characteristics**

Min/Max limits apply across temperature range unless otherwise noted

Symbol	Parameter	Conditions	Min	Тур	Max	Units
CMOS TO	смоѕ					
V <sub>IN(1)</sub>	Logical "1" Input Voltage	V <sub>CC</sub> = 5.0V	3.5			V
		V <sub>CC</sub> = 10V	8.0			V
V <sub>IN(0)</sub>	Logical "0" Input Voltage	V <sub>CC</sub> = 5.0V			1.5	V
		V <sub>CC</sub> = 10V			2.0	V
V <sub>OUT(1)</sub>	Logical "1" Output Voltage	$V_{CC} = 5.0V, I_{O} = -10 \mu A$	4.5			V
		$V_{CC} = 10V, I_{O} = -10 \mu A$	9.0			V
V <sub>OUT(0)</sub>	Logical "0" Output Voltage	V <sub>CC</sub> = 5.0V			0.5	V
		V <sub>CC</sub> = 10V			1.0	V
I <sub>IN(1)</sub>	Logical "1" Input Current	V <sub>CC</sub> = 15V, V <sub>IN</sub> = 15V		0.005	1.0	μΑ
I <sub>IN(0)</sub>	Logical "0" Input Current	V <sub>CC</sub> = 15V, V <sub>IN</sub> = 0V	-1.0	-0.005		μΑ
I <sub>cc</sub>	Supply Current	V <sub>CC</sub> = 15V		0.05	15	μΑ
TTL TO CN	ios	·				I.
V <sub>IN(1)</sub>	Logical "1" Input Voltage	V <sub>CC</sub> = 4.75V	V <sub>CC</sub> - 1.5			V
V <sub>IN(0)</sub>	Logical "0" Input Voltage	V <sub>CC</sub> = 4.75V			0.8	V
CMOS TO	TTL			J		ı
V <sub>IN(1)</sub>	Logical "1" Input Voltage					
	MM74C901	V <sub>CC</sub> = 4.75V	4.25			V
	MM74C902	$V_{CC} = 4.75V$	V <sub>CC</sub> - 1.5			V
V <sub>IN(0)</sub>	Logical "0" Input Voltage					
, ,	MM74C901	V <sub>CC</sub> = 4.75V			1.0	V
	MM74C902	V <sub>CC</sub> = 4.75V			1.5	V
V <sub>OUT(1)</sub>	Logical "1" Output Voltage	$V_{CC} = 4.75V, I_{O} = -800 \mu A$	2.4			V
V <sub>OUT(0)</sub>	Logical "0" Output Voltage					
	MM74C901	$V_{CC} = 4.75V, I_{O} = 2.6 \text{ mA}$			0.4	V
	MM74C902	$V_{CC} = 4.75V, I_{O} = 3.2 \text{ mA}$			0.4	V
OUTPUT D	RIVE (See Family Characteristics	Data Sheet) (Short Circuit Current)				1
(MM74C	901)					
SOURCE	Output Source Current	V <sub>CC</sub> = 5.0V, V <sub>OUT</sub> = 0V	-5.0			mA
	(P-Channel)	$T_A = 25^{\circ}C, V_{IN} = 0V$				
SOURCE	Output Source Current	V <sub>CC</sub> = 10V, V <sub>OUT</sub> = 0V	-20			mA
	(P-Channel)	$T_A = 25^{\circ}C, V_{IN} = 0V$				
I <sub>SINK</sub>	Output Sink Current	V <sub>CC</sub> = 5.0V, V <sub>OUT</sub> = V <sub>CC</sub>	9.0			mA
	(N-Channel)	$T_A = 25$ °C, $V_{IN} = V_{CC}$				
I <sub>SINK</sub>	Output Sink Current	V <sub>CC</sub> = 5.0V, V <sub>OUT</sub> = 0.4V	3.8			mA
	(N-Channel)	T <sub>A</sub> = 25°C, V <sub>IN</sub> = V <sub>CC</sub>				1

## DC Electrical Characteristics (Continued)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
I SOURCE	Output Source Current	V <sub>CC</sub> = 5.0V, V <sub>OUT</sub> = 0V	-5.0			mA
	(P-Channel)	$T_A = 25$ °C, $V_{IN} = V_{CC}$				
I SOURCE	Output Source Current	V <sub>CC</sub> = 10V, V <sub>OUT</sub> = 0V	-20			mA
	(P-Channel)	$T_A = 25$ °C, $V_{IN} = V_{CC}$				
I <sub>SINK</sub>	Output Sink Current	$V_{CC} = 5.0V$ , $V_{OUT} = V_{CC}$	9.0			mA
	(N-Channel)	$T_A = 25^{\circ}C, V_{IN} = 0V$				
I <sub>SINK</sub>	Output Sink Current	$V_{CC} = 5.0V, V_{OUT} = 0.4V$	3.8			mA
	(N-Channel)	$T_A = 25^{\circ}C, V_{IN} = 0V$				

### AC Electrical Characteristics (Note 2)

 $T_A = 25$ °C,  $C_L = 50$  pF, unless otherwise noted

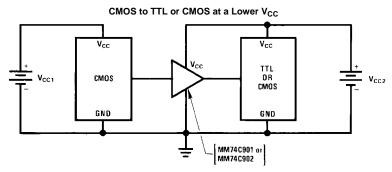
Symbol	Parameter	Conditions	Min	Тур	Max	Units
MM74C9	01		L	ı	ı	I
t <sub>pd1</sub>	Propagation Delay Time	V <sub>CC</sub> = 5.0V		38	70	ns
	to a Logical "1"	$V_{CC} = 10V$		22	30	ns
t <sub>pd0</sub>	Propagation Delay Time	V <sub>CC</sub> = 5.0V		21	35	ns
	to a Logical "0"	V <sub>CC</sub> = 10V		13	20	ns
C <sub>IN</sub>	Input Capacitance	Any Input (Note 3)		14		pF
C <sub>PD</sub>	Power Dissipation Capacity	Per Buffer (Note 4)		30		pF
MM74C9	02		•			
t <sub>pd1</sub>	Propagation Delay Time	V <sub>CC</sub> = 5.0V		57	90	ns
	to a Logical "1"	V <sub>CC</sub> = 10V		27	40	ns
t <sub>pd0</sub>	Propagation Delay Time	V <sub>CC</sub> = 5.0V		54	90	ns
	to a Logical "0"	V <sub>CC</sub> = 10V		25	40	ns
C <sub>IN</sub>	Input Capacitance	Any Input (Note 3)		5.0		pF
C <sub>PD</sub>	Power Dissipation Capacity	Per Buffer (Note 4)		50		pF

Note 2: AC Parameters are guaranteed by DC correlated testing.

Note 3: Capacitance is guaranteed by periodic testing.

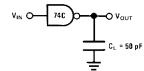
Note 4: C<sub>PD</sub> determines the no load AC power consumption of any CMOS device. For complete explanation see Family Characteristics application note AN-90.

# **Typical Application**

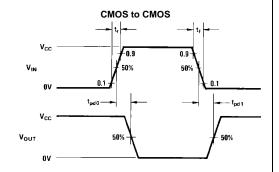


Note:  $V_{CC1} = V_{CC2}$ 

# **AC Test Circuit and Switching Time Waveforms**

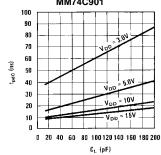


Note: Delays measured with input  $t_r$ ,  $t_f$  = 20 ns.

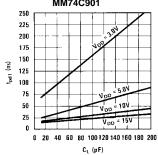


# **Typical Performance Characteristics**

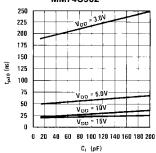
Typical Propagation Delay to a Logical "0" for the MM74C901



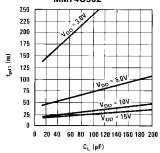
Typical Propagation Delay to a Logical "1" for the MM74C901

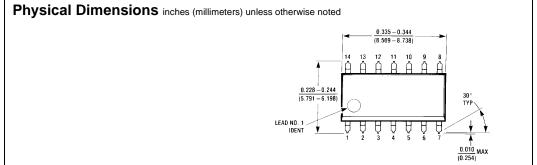


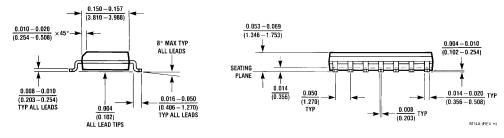
Typical Propagation Delay to a Logical "0" for the MM74C902



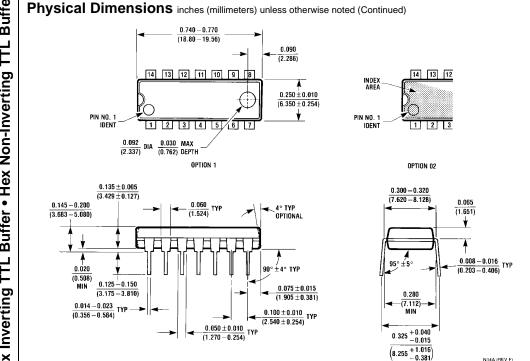
Typical Propagation Delay to a Logical "1" for the MM74C902







14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-120, 0.150" Narrow Package Number M14A



14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N14A

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